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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Kenneth P. Rodbell

Group Art Unit: 1753

Serial No.: 10/055,134

Examiner: Phasge, Arun S.

Filed: Jan. 22, 2002

In Response to Office Action

Dated: Oct. 14, 2003

For: Method For Plating Copper Conductors and Devices Formed

Attorney Docket No.: 64,610-043A (YO998-503)

Certificate of Mailing

I hereby certify that this paper (along with any referred to as being attached or enclosed) is being deposited with the United States Postal Service on the date shown below with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Date: Jan. 8, 2004

Kathy Dixon

RESPONSE TO OFFICE ACTION

Commissioner for Patents
Alexandria, VA 22313-1450

Dear Sir:

In response to an Office Action mailed Oct. 14, 2003, please enter the following amendments and consider the following remarks.